

SMP75-8

TRISIL TM

FEATURES

- Bidirectional surge arrestor.
- Very low stand-off voltage : V_{RM} = 8 V.

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- High repetitive surge capability:
 I_{PP} = 75 A (10/1000μs).
- Very low capacitance : C < 75 pF</p>
- Low leakage current : < 2 μA</p>

DESCRIPTION

The SMP75-8 is a very low voltage transient surge arrestor especially designed to protect sensitive telecommunication equipment against lightning strikes and other transients.

MAIN APPLICATION

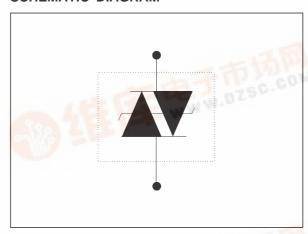
XDSL TRANSMISSION EQUIPMENT

BENEFITS

- Protection against high energy surges.
- Very low breakover voltage: V_{BO} < 15 V, thus avoiding saturation of transformer.
- No signal distortion thanks to very low capacitance.



SCHEMATIC DIAGRAM



COMPLIES WITH THE FOLLOWING STANDARDS:

- BELLCORE TR-NWT -000974: $10/1000 \mu s$ 1 kV 10/1000 μs 75A * - CCITT K20: $10/700 \, \mu s$ 4 kV $5/310 \, \mu s$ 100A - VDE 0433: 10/700 µs 4 kV 5/310 µs 100A - VDE 0878: 1.2/50 μs 4 kV

1/20 µs

100A

* with series resistor or PTC.



SMP75-8

ABSOLUTE MAXIMUM RATINGS $(T_{amb} = 25^{\circ}C)$

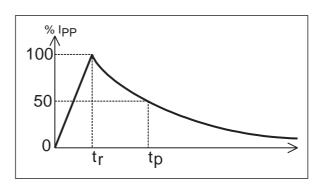
Symbol	Parameter	Value	Unit	
I_{pp}	Peak pulse current	10/1000μs 8/20μs	75 250	A A
I _{TSM}	Non repetitive surge peak on-state current One cycle	35 37	A A	
	Non repetitive surge peak on-state current F = 50Hz	0.2s 2s	14 6	A A
Tı	Maximum lead temperature for soldering duri	260	°C	
T _{stg} Tj	Storage temperature range Maximum junction temperature		- 55 to + 150 150	ပ္

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
R _{th(j-I)}	Junction to leads	20	°C/W
R _{th(j-a)}	Junction to ambient on printed circuit (with standard footprint dimensions)	100	°C/W

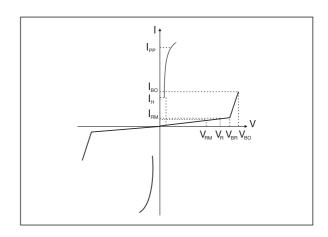
Note 1: Pulse waveform

10 / 1000 μs	$tr = 10 \mu s$	tp = 1000 μs
$8/20\mu s$	$tr = 8 \mu s$	$tp = 20 \mu s$
5 / 310 μs	$tr = 5 \mu s$	$tp = 310 \mu s$
1 / 20 μs	$tr = 1 \mu s$	$tp = 20 \mu s$
2 / 10 us	$tr = 2 \mu s$	$t_0 = 10 \mu s$



ELECTRICAL CHARACTERISTICS (T_{amb} = 25°C)

Symbol	Parameter			
V_{RM}	Stand-off voltage			
I _{RM}	Leakage current at stand-off volt- age			
V _R	Continuous Reverse voltage			
V_{BR}	Breakdown voltage			
V_{BO}	Breakover voltage			
I _H	Holding current			
I _{BO}	Breakover current			
I _{PP}	Peak pulse current			



STATIC PARAMETERS

Туре	I _{RM} @ V _{RM} max.		I _R @ V _R max. note 1		V _{BO} @ I _{BO} max. note 2		I _H typ. note 3	C max. note 4
	μΑ	V	μΑ	V	V	mA	mA	pF
SMP75-8	2	6	50	8	15	800	50	75

Note 1 : IR measured at VR guarantees VBR>VR Note 2 : Measured at 50Hz, see test circuit 1. In any case VBOmin | VBR

Note 3: See functional holding current test circuit 2.

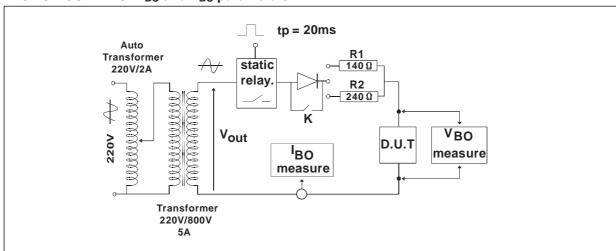
Note 4: VR=1V bias, VRMS=1V, F=1MHz.

DYNAMIC PARAMETERS

Symbol	Test conditions (see note 5)	Туре	Max.	Unit
V BO	Test conditions 1 $V_{RISE} = 100 \text{ V/}\mu\text{s}$, di/dt < 10 A/ μ s, I _{PP} = 75 A	SMP75-8	20	v
	Test conditions 2 $V_{RISE} = 1 \text{ kV/}\mu\text{s}$, di/dt < 10 A/ μ s, I _{PP} = 10 A	J 10 0		_

Note 5: VBO parameters are given by a KeyTek 'System 2' generator with PN246I module. See test circuits (3) for VBO dynamic parameters.

TEST CIRCUIT 1 FOR IBO and VBO parameters :



TEST PROCEDURE:

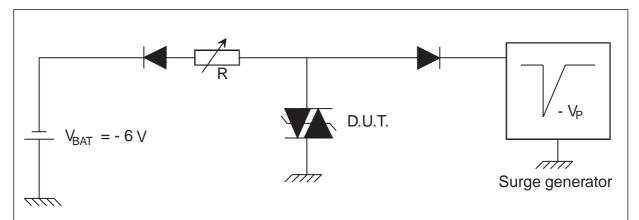
Pulse Test duration (tp = 20ms):

- For Bidirectional devices = Switch K is closed
- For Unidirectional devices = Switch K is open.

Vour Selection

- Device with V_{BO} < 200 Volt V_{OUT} = 250 V_{RMS} , R_1 = 140 Ω . Device with V_{BO} | 200 Volt
- - $V_{OUT} = 480 V_{RMS}$, $R_2 = 240 \Omega$.

FUNCTIONAL HOLDING CURRENT (IH) TEST CIRCUIT 2: GO-NO GO TEST

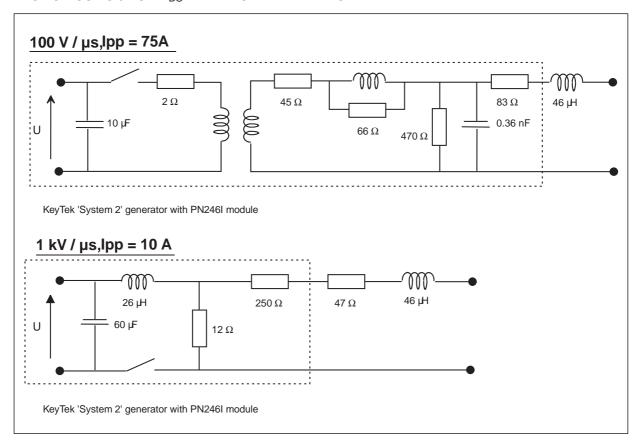


This is a GO-NO GO test which allows to confirm the holding current (I_H) level in a functional test circuit.

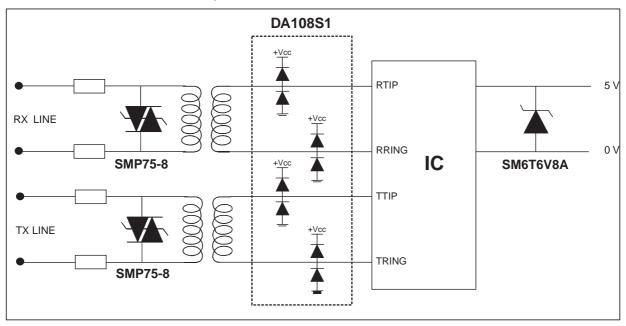
TEST PROCEDURE:

- Adjust the current level at the I_H value by short circuiting the D.U.T.
- Fire the D.U.T. with a surge current : I_{pp} = 10A, 10/1000 μs .
- The D.U.T. will come back to the OFF-state within a duration of 50 ms max.

TEST CIRCUITS 3 FOR V_{BO} DYNAMIC PARAMETERS







The above schematic shows a T1 / E1 application circuit. This type of line protection may be used in premises equipment or telephone company equipment on ports directly connected to metallic plant lines.

During the lightning surge, the low voltage Trisil **SMP75-8** provides an efficient crowbar protection on the primary side of the transformer.

The SMP75-8 has a maximum peak pulse current of 75A ($10/1000\mu s$ pulse) and a maximum breakover voltage of 15V. This low voltage prevents the transformer to be satured when a surge occurs on the line. Additionally, the low capacitance (65pF) is required to avoid significant signal degradation in the case of high speed digital pulses.

To protect the IC line interface from the remaining energy which is coupled through the transformer, additional voltage protection is recommended on

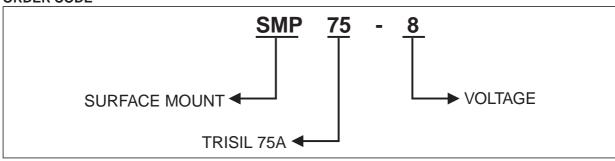
the line input / output pins of the IC. The diode array DA108S1 connected between +Vcc and GND is then used to limit the remaining overvoltage within a safe level.

The DA108S1 is especially dedicated to this application because. Its fast response time and low forward voltage drop enable it to clamp any surge before the IC line interface internal protection fails. Additionally, the low capacitance (30pF) is required to prevent signal degradation of the high speed datd.

The DA108S1 is a fully integrated (1 chip) device and results from the ST ASDTM(Application Specific Discretes) technology. ASDsTM combine the functions of several components into a single monolithic device that is tailored to meet the exact requirement of a specific application, allowing higher density and improved reliability.

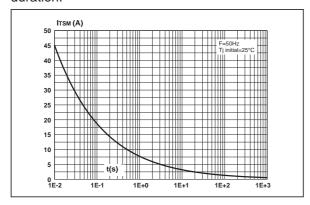
The unidirectional TransilTM **SM6T6V8A** is used to clamp surges coupled onto the power supply.

ORDER CODE



SMP75-8

Non repetitive surge peak current versus overload duration.

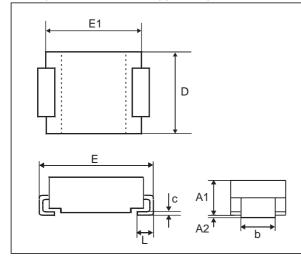


MARKING

Package	Туре	Marking	
SMB	SMP75-8	L08	

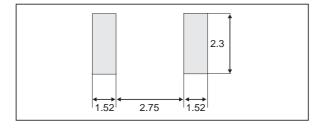
PACKAGE MECHANICAL DATA

SMB (JEDEC DO-214AA)(Plastic)



	DIMENSIONS					
REF.	Mi	llimete	ers	Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
A1	1.90	2.15	2.45	0.075	0.085	0.096
A2	0.05	0.15	0.20	0.002	0.006	0.008
b	1.95		2.20	0.077		0.087
С	0.15		0.41	0.006		0.016
Е	5.10	5.40	5.60	0.201	0.213	0.220
E1	4.05	4.30	4.60	0.159	0.169	0.181
D	3.30	3.60	3.95	0.130	0.142	0.156
L	0.75	1.15	1.60	0.030	0.045	0.063

FOOT PRINT (in millimeters)



Packaging: tape and reel

Weight: 0.12g

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